

SOT-363**200mA,30V肖特基二极管阵列****200mA,30V Schottky Barrier Diode Array**

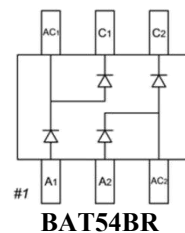
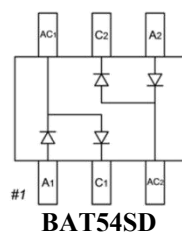
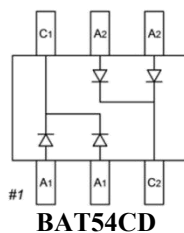
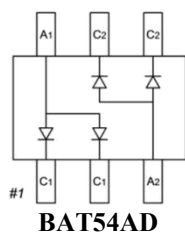
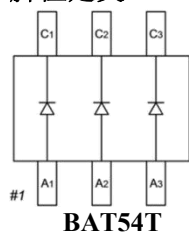
产品特性总结Product Summary	
I_F	200mA
V_{RRM}	30V
I_{FSM}	600mA

特征 Features

- 高开关速度Fast Switching Speed
- 低正向压降Low Forward Voltage Drop
- 无卤、RoHS认证Halogen-free、RoHS Compliant
- 表贴型封装Surface Mount Package

应用 Applications

- 电压钳位Voltage Clamping
- 反极性保护Reverse Polarity Protection
- 高速开关High Speed Switching

脚位定义Pin Definition

极限值和温度特性($T_A = 25^\circ\text{C}$ 除非另有规定)

Maximum Ratings & Thermal Characteristics (Ratings at 25°C ambient temperature unless otherwise specified.)

参数 Parameters	符号 Symbol	数值 Value					单位 Unit
		BAT54T	BAT54AD	BAT54CD	BAT54SD	BAT54BR	
印字代码Marking Code		KLA	KL6	KL7	KL8	KLB	
重复峰值反向电压 Repetitive Peak Reverse Voltage	V_{RRM}	30					V
重复峰值正向电流 Repetitive Peak Forward Current	I_{FRM}	300					mA
正向电流Forward Current	I_F	200					mA
峰值不重复正向浪涌电流 Non-Repetitive Peak Forward Surge Current @ $t < 1.0\text{s}$	I_{FSM}	600					mA
功耗Power Dissipation	P_D	200					mW
结环热阻Junction-to-Ambient Thermal Resistance	$R_{\theta JA}$	625					$^\circ\text{C}/\text{W}$
结温和存储温度Junction and Storage Temperature	T_J 、 T_{STG}	$-65 \sim +150$					$^\circ\text{C}$

电特性 ($T_A = 25^\circ\text{C}$ 除非另有规定)

Electrical Characteristics (Ratings at 25°C ambient temperature unless otherwise specified.)

参数 Parameters	符号 Symbol	测试条件 Test Condition	最小值 Min	典型值 Typ	最大值 Max	单位 Unit
每个二极管的正向电压 Forward Voltage per Diode(Note1)	V_F	$I_F = 0.1\text{mA}, T_J = 25^\circ\text{C}$	--	--	0.24	V
		$I_F = 1\text{mA}, T_J = 25^\circ\text{C}$	--	--	0.32	
		$I_F = 10\text{mA}, T_J = 25^\circ\text{C}$	--	--	0.40	
		$I_F = 30\text{mA}, T_J = 25^\circ\text{C}$	--	--	0.50	
		$I_F = 100\text{mA}, T_J = 25^\circ\text{C}$	--	--	1.00	
反向电压 Reverse Voltage	V_R	$I_R = 100\mu\text{A}, T_J = 25^\circ\text{C}$	30	--	--	V

反向漏电流 Reverse Current @Rated V_R per Diode (Note2)	I_R	$V_R=25V, T_J = 25^\circ C$	--	--	2	μA
总电容 Total Capacitance	C_T	$1MHz, V_R=1V$	0.5	--	10	pF
反向恢复时间 Reverse Recovery Time	t_{rr}	$I_F=I_R=10mA, R_L=100\Omega, I_{RR}=1mA$	--	--	5	nS

*Notes :

1. Pulse test with $PW=0.3ms$.
2. Pulse test with $PW=30ms$.

典型特性曲线 Typical characteristics

Fig.1 Typical Forward Characteristics

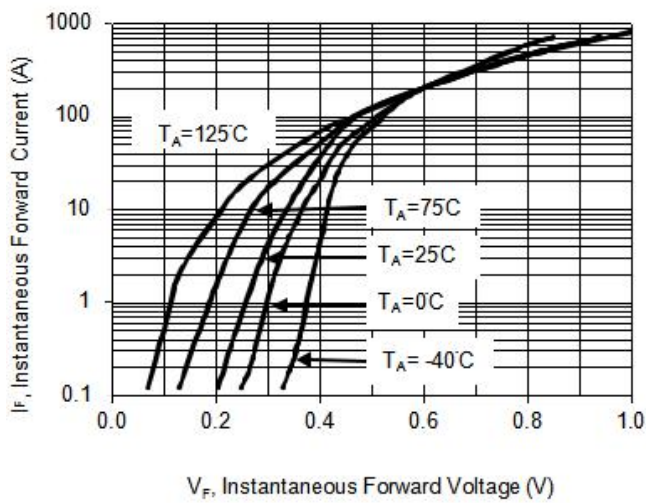
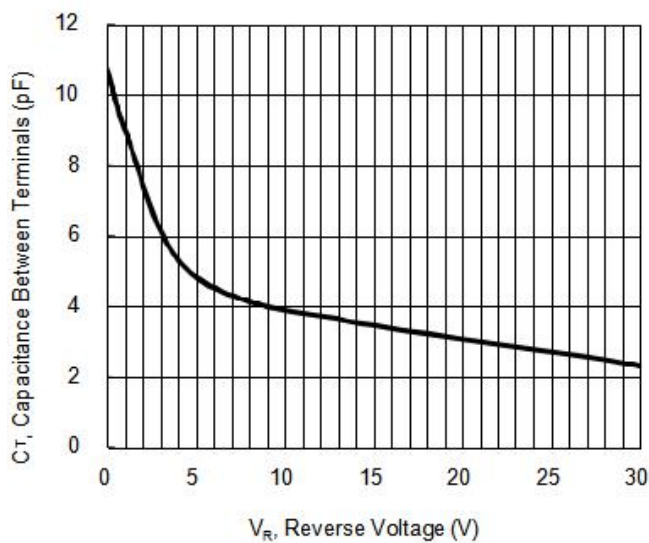
Fig.3 Capacitance Between
Terminals Characteristics

Fig. 2 Typical Reverse Characteristics

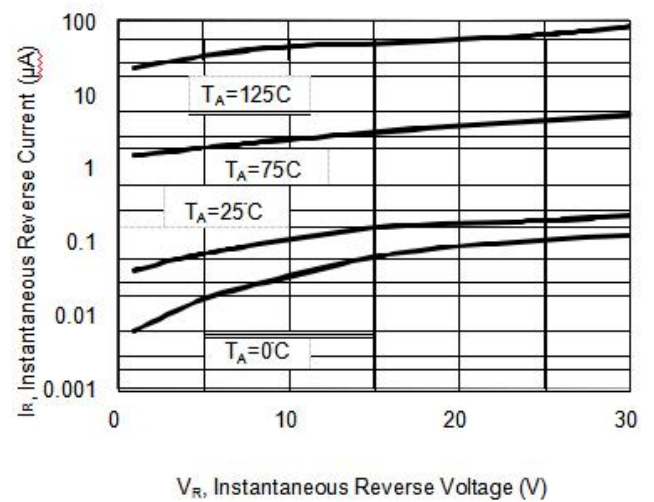
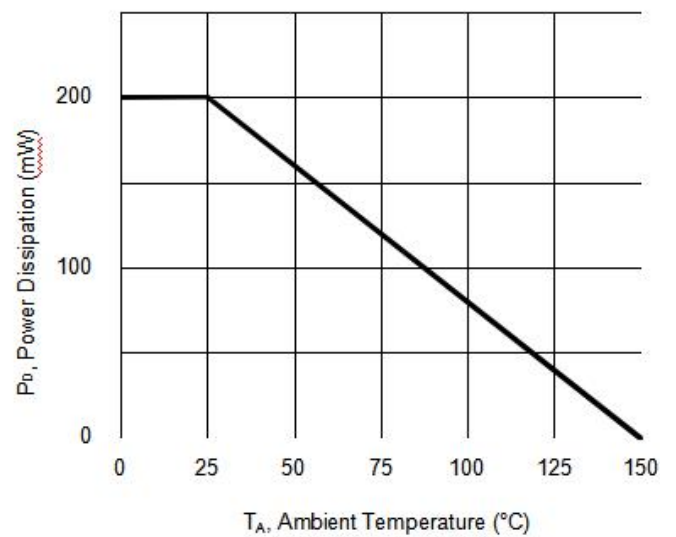
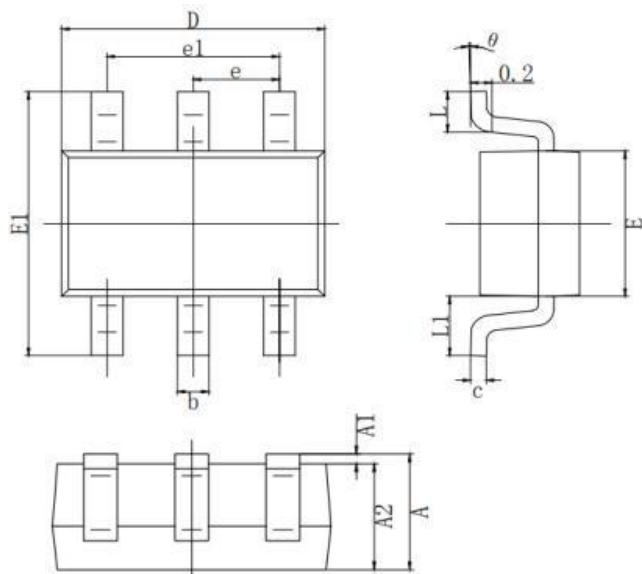


Fig.4 Power Derating Curve



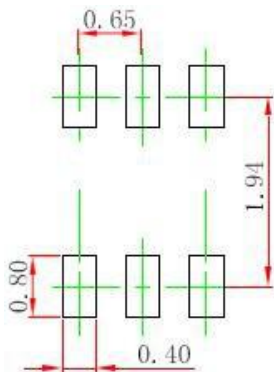
封装外形图 SOT-363 Package Outline Dimensions



SYMBOL	MILLIMETER	
	MIN	MAX
A	0.900	1.100
A1	0.000	0.100
A2	0.900	1.000
b	0.150	0.350
c	0.080	0.150
D	2.000	2.200
E	1.150	1.350
E1	2.150	2.450
e	0.650 TYP.	
e1	1.200	1.400
L	0.525 REF.	
L1	0.260	0.460
θ	0°	8°

焊盘设计参考Precautions: PCB Design

Recommended land dimensions for SOT-363. Electrode patterns for PCBs



- Note:
1. Controlling dimension: in millimeters.
 2. General tolerance: $\pm 0.05\text{mm}$.
 3. The pad layout is for reference purposes only.